April 2000

FDS9412

SEMICONDUCTOR IM

Single N-Channel Enhancement Mode Field Effect Transistor

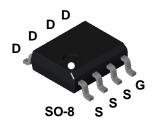
General Description

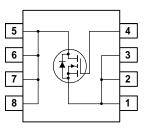
This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are particularly suited for low voltage applications such as notebook computer DC-DC converter where fast switching, low conduction loss and high efficiency are needed.

Features

- 7.9 A, 30 V. $R_{DS(ON)} = 22 \ m\Omega \ @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 36 \ m\Omega \ @ V_{GS} = 4.5 \ V$
- Very low gate charge.
- High switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability in a widely used surface mount package.





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol		Parameter		Ratings	Units	
V _{DSS}	Drain-Source	ce Voltage		30	V	
V _{GSS}	Gate-Sourc	e Voltage		±20	V	
ID	Drain Curre	nt – Continuous	(Note 1a)	7.9	А	
		 Pulsed 		24		
P _D	Power Diss	ipation for Single Operatio	n (Note 1a)	2.5	W	
			(Note 1b)	1.2		
			(Note 1c)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150		
Therma	I Charac	teristics				
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)		Dient (Note 1a)	50	°C/W	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)			25 °C		
Packag	e Markin	g and Ordering I	nformation			
Device Marking		Device	Reel Size	Tape width	Quantity	
FDS9412		FDS9412	13"	12mm	2500 units	

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FDS9412 Rev D(W)

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	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		28		mV/°0
IDSS	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 V V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)				•	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	1.6	2.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C		-4.3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 10 \; V, \;\; I_D = 7.9 \; A \\ V_{GS} = 10 \; V, \;\; I_D = 7.9 \; A, \; T_J \!=\! 125^\circ \! C \\ V_{GS} = 4.5 \; V, \;\; I_D = 6.2 \; A \end{array} $		19 30 25	22 35 36	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	16			A
g fs	Forward Transconductance	$V_{DS} = 10 V$, $I_D = 7.9 A$		22		S
Dynamic	c Characteristics					
Ciss	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		830		pF
Coss	Output Capacitance	f = 1.0 MHz		185		pF
C _{rss}	Reverse Transfer Capacitance			80		pF
Switchir	g Characteristics (Note 2)				•	
t _{d(on)}	Turn-On Delay Time	$V_{\text{DD}} = 10 \text{ V}, I_{\text{D}} = 1 \text{ A},$		6	12	ns
tr	Turn–On Rise Time	$V_{GS} = 10$ V, $R_{GEN} = 6 \Omega$		10	20	ns
t _{d(off)}	Turn-Off Delay Time	-		18	32	ns
t _f	Turn–Off Fall Time	-		5	10	ns
Qg	Total Gate Charge	$V_{DS} = 12 V, I_D = 7.9 A,$		14	22	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 10 V$		2.7		nC
Q _{gd}	Gate-Drain Charge	-		3.0		nC
ad	ource Diode Characteristics	and Maximum Ratings	1	1	1	1
-		je			2	А
-	Maximum Continuous Drain–Source	e Diode Forward Current			<u> </u>	

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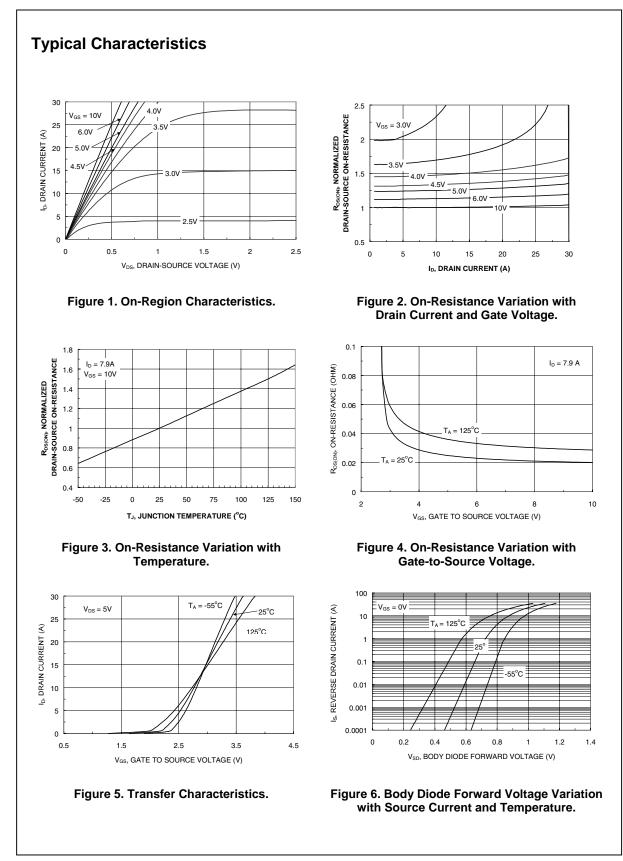
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Scale 1 : 1 on letter size paper

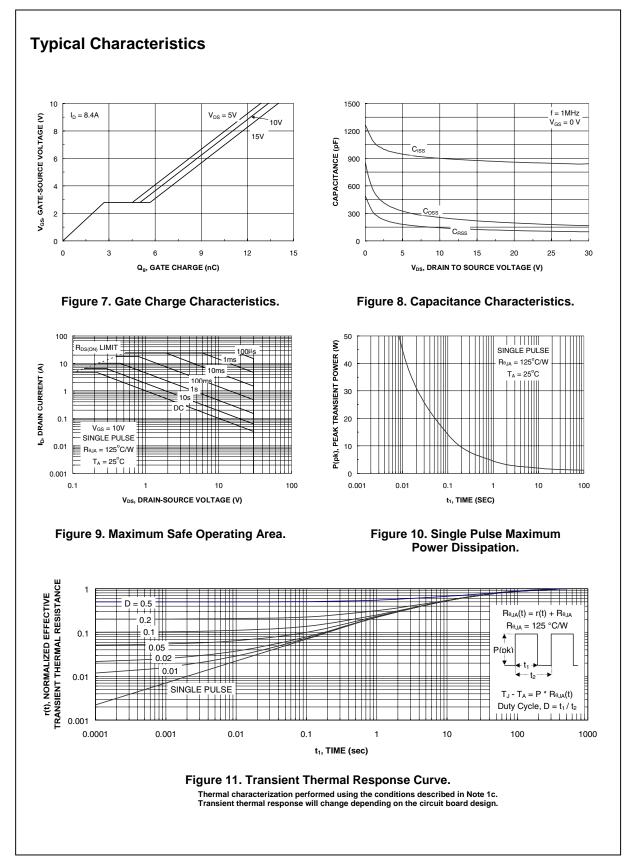
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

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|--------------------------|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
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